

# SANYO Semiconductors

DATA SHEET

An ON Semiconductor Company

# MCH3474 —

# N-Channel Silicon MOSFET **General-Purpose Switching Device Applications**

· Ultrahigh speed switching

· Halogen free compliance

# **Features**

- · Low ON-resistance
- 1.8V drive
- · Protection diode in

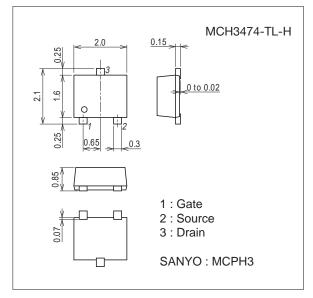
## **Specifications**

#### Absolute Maximum Ratings at Ta=25°C

	<u> </u>			
Parameter	Symbol	Conditions	Ratings	Unit
Drain-to-Source Voltage	VDSS		30	V
Gate-to-Source Voltage	VGSS		±12	V
Drain Current (DC)	۱ <sub>D</sub>		4	A
Drain Current (Pulse)	IDP	PW⊴10µs, duty cycle≤1%	16	A
Allowable Power Dissipation	PD	When mounted on ceramic substrate (900mm <sup>2</sup> ×0.8mm)	1	W
Channel Temperature	Tch		150	°C
Storage Temperature	Tstg		-55 to +150	°C

#### **Package Dimensions**

unit : mm (typ) 7019A-003



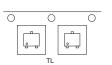
#### Product & Package Information

Package

• JEITA, JEDEC

: SC-70, SOT-323 • Minimum Packing Quantity : 3,000 pcs./reel

#### Packing Type : TL

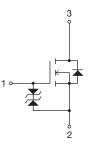




Marking

: MCPH3

**Electrical Connection** 

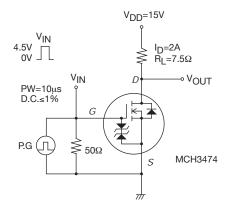


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	Electrical	<b>Characteristics</b> at Ta=25°C	
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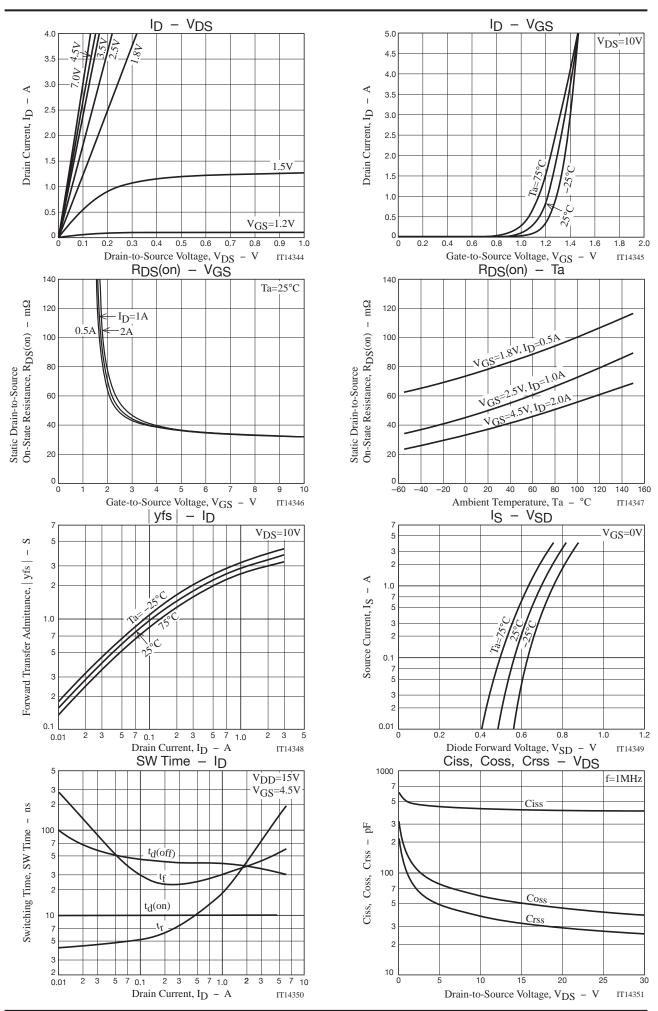
Parameter	Cumphial	Conditions	Ratings			11-24	
Parameter	Symbol	Conditions	min	typ	max	Unit	
Drain-to-Source Breakdown Voltage	V(BR)DSS	ID=1mA, VGS=0V	30			V	
Zero-Gate Voltage Drain Current	IDSS	V <sub>DS</sub> =30V, V <sub>GS</sub> =0V			1	μΑ	
Gate-to-Source Leakage Current	IGSS	V <sub>GS</sub> =±8V, V <sub>DS</sub> =0V			±10	μΑ	
Cutoff Voltage	V <sub>GS</sub> (off)	V <sub>DS</sub> =10V, I <sub>D</sub> =1mA	0.4		1.3	V	
Forward Transfer Admittance	yfs	V <sub>DS</sub> =10V, I <sub>D</sub> =2A	2.0	3.4		S	
	R <sub>DS</sub> (on)1	ID=2A, VGS=4.5V		38	50	mΩ	
Static Drain-to-Source On-State Resistance	R <sub>DS</sub> (on)2	ID=1A, VGS=2.5V		51	72	mΩ	
	R <sub>DS</sub> (on)3	I <sub>D</sub> =0.5A, V <sub>GS</sub> =1.8V		80	130	mΩ	
Input Capacitance	Ciss			430		pF	
Output Capacitance	Coss	VDS=10V, f=1MHz		59		pF	
Reverse Transfer Capacitance	Crss			38		pF	
Turn-ON Delay Time	t <sub>d</sub> (on)			10		ns	
Rise Time	t <sub>r</sub>			41		ns	
Turn-OFF Delay Time	t <sub>d</sub> (off)	See specified Test Circuit.		36		ns	
Fall Time	tf	-		37		ns	
Total Gate Charge	Qg			4.7		nC	
Gate-to-Source Charge	Qgs	V <sub>DS</sub> =15V, V <sub>GS</sub> =4.5V, I <sub>D</sub> =4A		0.8		nC	
Gate-to-Drain "Miller" Charge	Qgd	1		1.1		nC	
Diode Forward Voltage	V <sub>SD</sub>	IS=4A, VGS=0V		0.82	1.2	V	

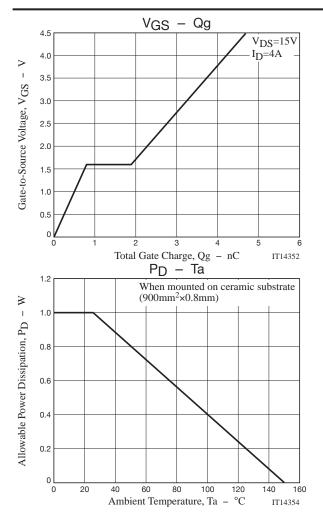
# Switching Time Test Circuit

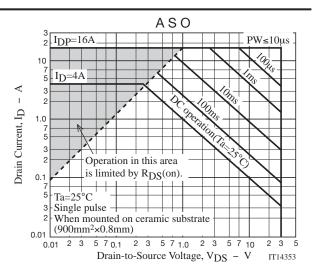


### **Ordering Information**

Device	Package	Shipping	memo
MCH3474-TL-H	MCPH3	3,000pcs./reel	Pb Free and Halogen Free







## Taping Specification MCH3474-TL-H

1. Packing Format

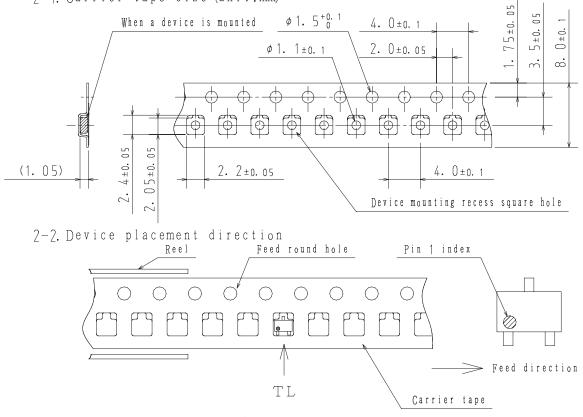
Packing method (unified filling) The form of a label may change in physical distribution process.   Image: Structure filling fill	Package Name	Carrier Tape		mun Numbe s contain		Packing format
Michael Higher Highe		Туре	Reel	Inner box	Outer box	Inner BOX (C-1) Outer BOX (A-7)
Packing method Dimensions:mm (external) Dimensions:mm (external)   Packing method Reel label, Inner box label Quart itym   Image: Construction of the terminal is lead free. Image: Construction of the terminal is lead free.	МСРН 3	MCPH3	3,000	15,000	90,000	5 reels contained 6 inner boxes contained
Packing method Reel label, Inner box label (unit:mm) Outer box label It is a label at the time of factory shipments. The form of a label may change in physical distribution process.						Dimensions:mm (external) Dimensions:mm (external)
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LEAD FREE 4

JEITA Phase 3

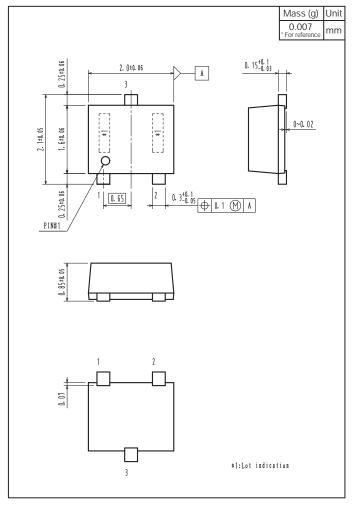
2. Taping configuration

2-1. Carrier tape size (unit:mm)

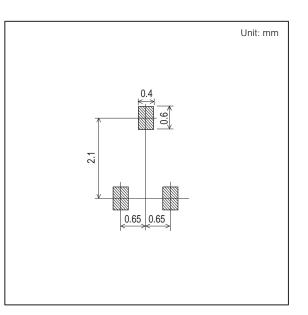


Those with pin 1 index on the feed hole side  $\cdots \cdots TL$ 

# Outline Drawing MCH3474-TL-H



# Land Pattern Example



Note on usage : Since the MCH3474 is a MOSFET product, please avoid using this device in the vicinity of highly charged objects.

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